

### Product Summary

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	$I_D$
100V	140mΩ@10V	3A
	300mΩ@4.5V	

### Feature

- Split Gate Trench MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low  $R_{DS(ON)}$

### Application

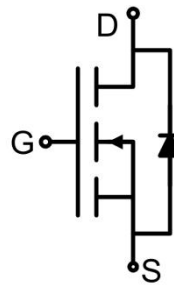
- DC/DC Converter
- Power management functions

### Package

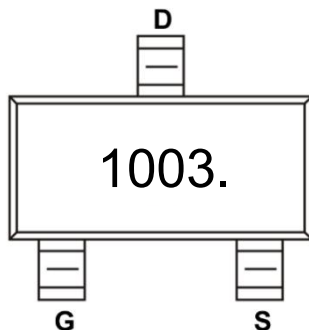


SOT-23

### Circuit diagram



### Marking



### Absolute maximum ratings ( $T_A=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	100	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current	$I_D$	3	A
Pulsed Drain Current <sup>1)</sup>	$I_{DM}$	12	A
Avalanche energy <sup>2)</sup>	$E_{AS}$	8	mJ
Power Dissipation <sup>3)</sup>	$P_D$	1.2	W
Thermal Resistance from Junction to Ambient( $t \leq 10\text{S}$ ) <sup>4)</sup>	$R_{\theta JA}$	104	$^{\circ}\text{C}/\text{W}$
Junction Temperature	$T_J$	150	$^{\circ}\text{C}$
Storage Temperature	$T_{STG}$	-55 ~ +150	$^{\circ}\text{C}$

### Electrical characteristics ( $T_J=25^{\circ}\text{C}$ , unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$	100			V
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = 100\text{V}, V_{GS} = 0\text{V}$			1	$\mu\text{A}$
Gate-body leakage current	$I_{GSS}$	$V_{GS} = \pm 20\text{V}, V_{DS} = 0\text{V}$			$\pm 100$	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1.0	1.8	2.5	V
Drain-source on-resistance	$R_{DS(on)}$	$V_{GS} = 10\text{V}, I_D = 3\text{A}$		110	140	m $\Omega$
		$V_{GS} = 4.5\text{V}, I_D = 2\text{A}$		160	300	
<b>Dynamic characteristics<sup>5)</sup></b>						
Input Capacitance	$C_{iss}$	$V_{DS} = 50\text{V}, V_{GS} = 0\text{V}, f = 100\text{KHz}$		206		pF
Output Capacitance	$C_{oss}$			28.9		
Reverse Transfer Capacitance	$C_{rss}$			1.4		
Total Gate Charge	$Q_g$	$V_{DS} = 50\text{V}, V_{GS} = 10\text{V}, I_D = 3\text{A}$		4.3		nC
Gate-Source Charge	$Q_{gs}$			1.5		
Gate-Drain Charge	$Q_{gd}$			1.1		
Reverse Recovery Charge	$Q_{rr}$	$I_F = 3\text{A}, di/dt = 100\text{A}/\mu\text{s}$		39.4		nC
Reverse Recovery Time	$t_{rr}$			32.1		
Turn-on delay time	$t_{d(on)}$	$V_{DD} = 50\text{V}, V_{GS} = 10\text{V}$ $I_D = 3\text{A}, R_{GEN} = 2\Omega$		14.7		nS
Turn-on rise time	$t_r$			3.5		
Turn-off delay time	$t_{d(off)}$			20.9		
Turn-off fall time	$t_f$			2.7		
<b>Source-Drain Diode characteristics</b>						
Diode Forward Current	$I_S$				3	A
Diode Forward voltage	$V_{SD}$	$V_{GS} = 0\text{V}, I_S = 3\text{A}$			1.3	V

Notes:

- 1) Repetitive rating; pulse width limited by max. junction temperature.
- 2)  $V_{DD} = 50\text{V}, R_G = 25\Omega, L = 0.5\text{mH}$ .
- 3)  $P_D$  is based on max. junction temperature, using  $\leq 10\mu\text{s}$  junction-to-ambient thermal resistance.
- 4) The value of  $R_{\theta JA}$  is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^{\circ}\text{C}$ . The value in any given application depends on the user's specific board design.
- 5) Guaranteed by design, not subject to production testing.

## Typical Characteristics

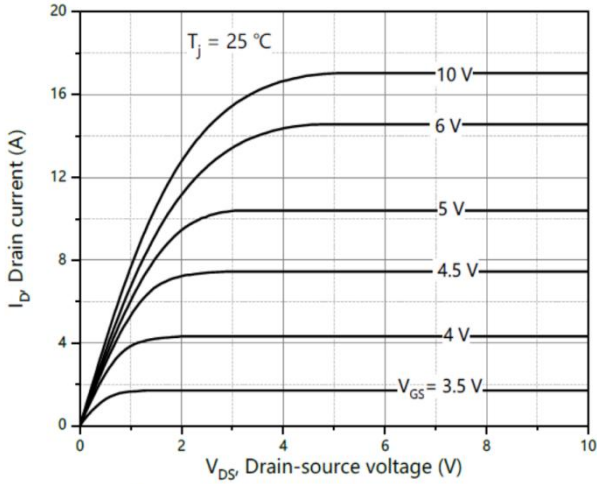


Figure1. Output Characteristics

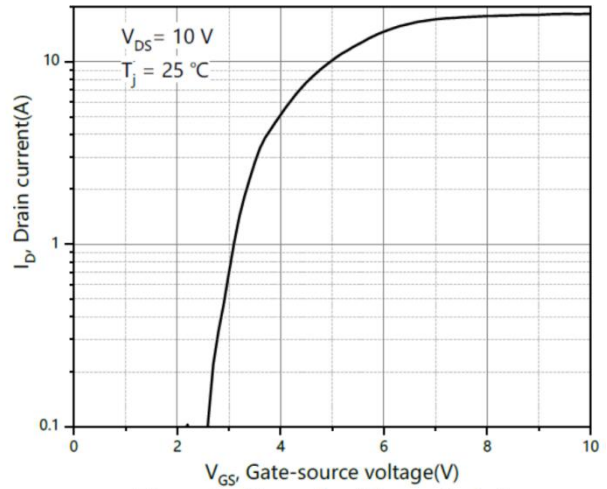


Figure2. Transfer Characteristics

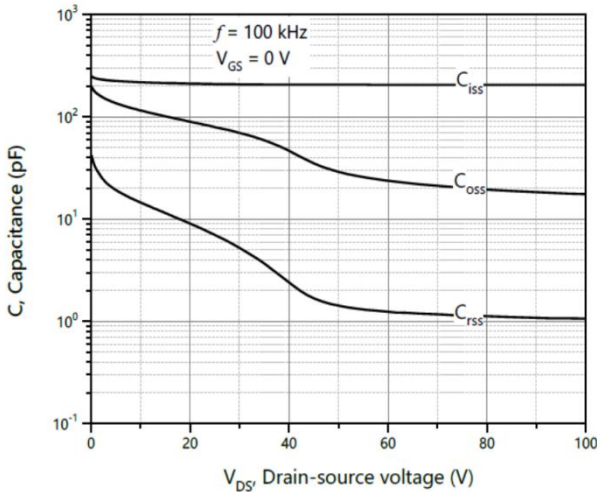


Figure3. Capacitance Characteristics

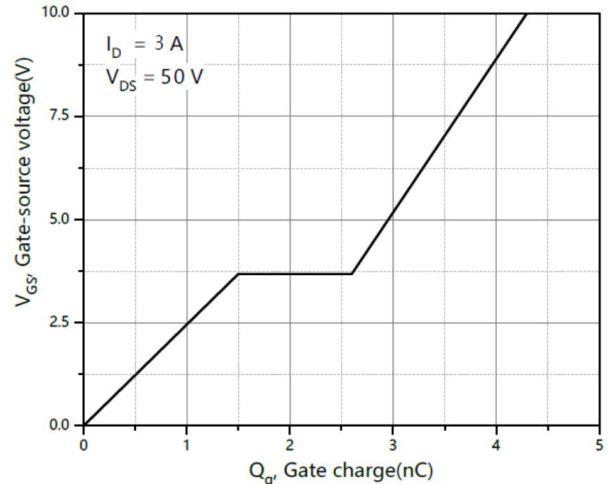


Figure4. Gate Charge

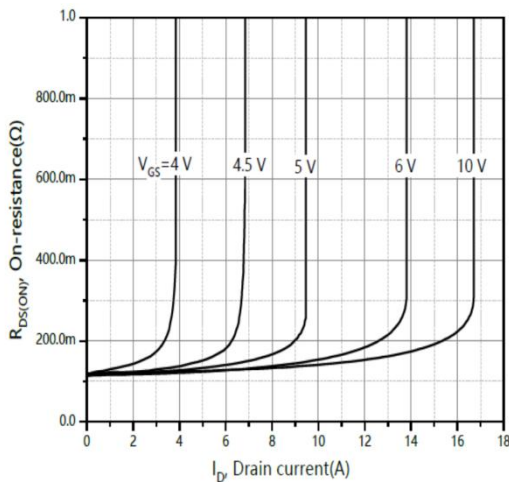


Figure5. : On-Resistance vs. Drain Current and Gate Voltage

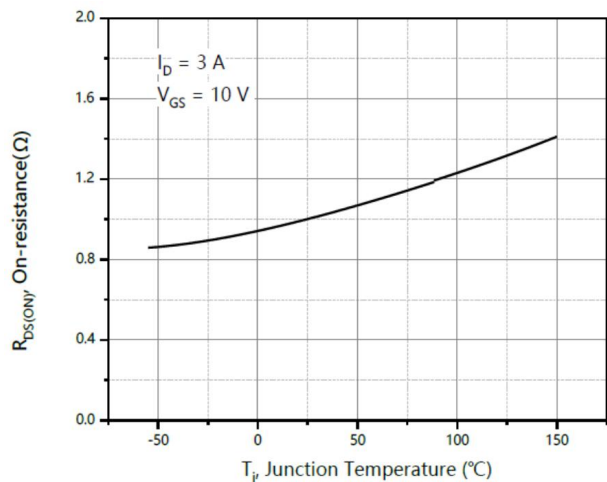


Figure6. Normalized On-Resistance

## Typical Characteristics

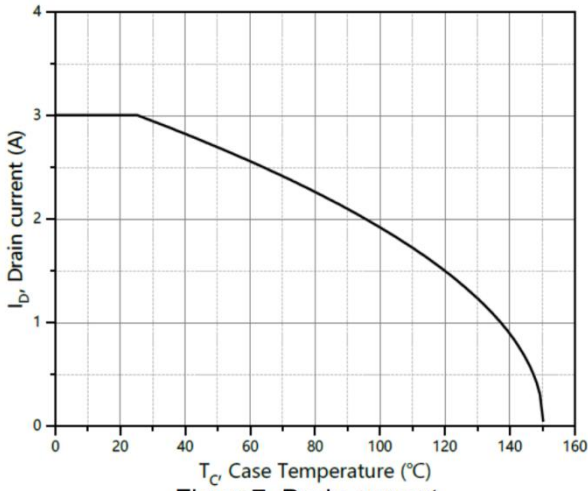


Figure 7. Drain current

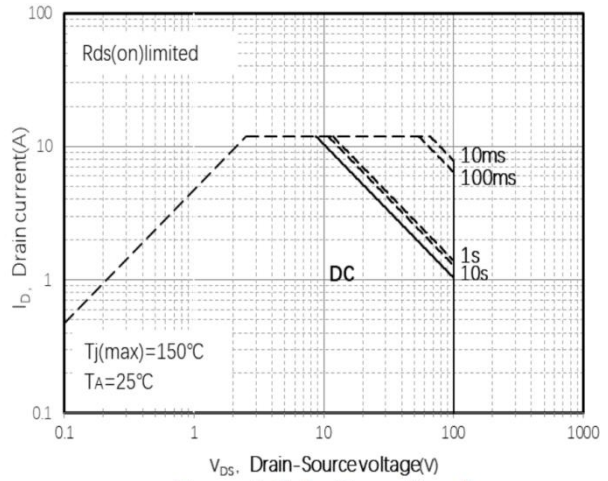


Figure 8. Safe Operation Area

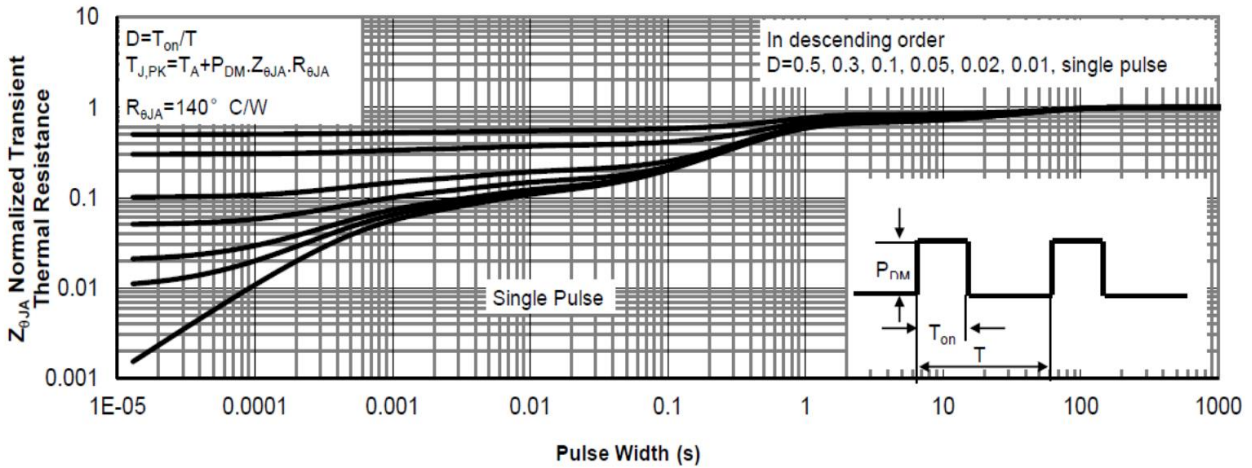


Figure 9. Normalized Maximum Transient thermal impedance

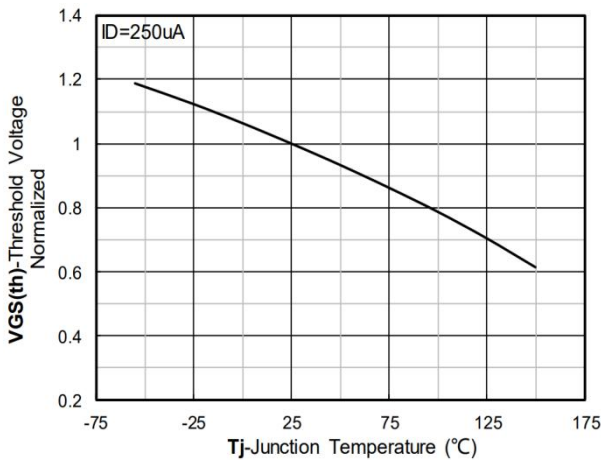
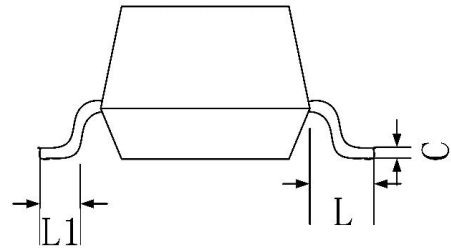
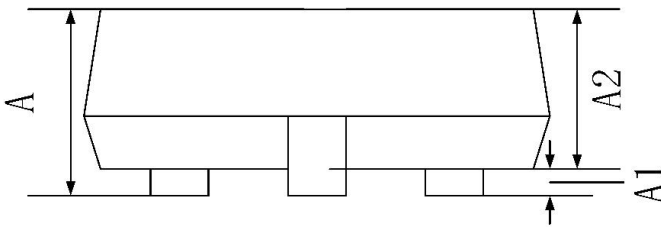
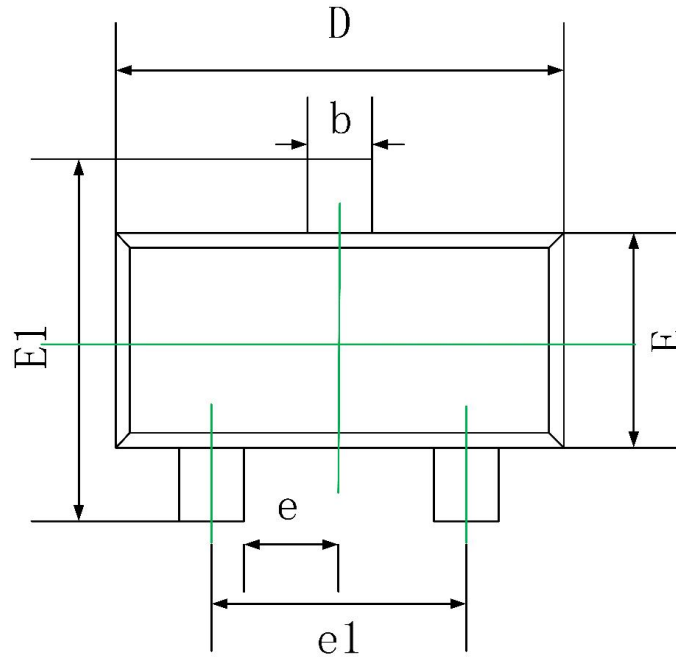


Figure 10. Normalized Threshold voltage

## SOT-23 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.200	0.003	0.008
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP.		0.037 TYP.	
e1	1.800	2.000	0.071	0.079
L	0.550 REF.		0.022 REF.	
L1	0.300	0.500	0.012	0.020